Praetorian[®] L-C LCD and Camera EMI Filter Array with ESD Protection

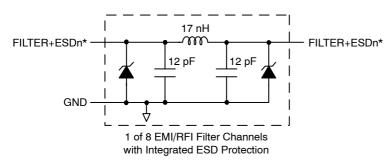
Features

- Eight Channels of EMI Filtering with Integrated ESD Protection
- Pi-Style EMI Filters in a Capacitor-Inductor-Capacitor (C-L-C) Network
- ±15 kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- ±30 kV ESD Protection on Each Channel (HBM)
- Greater than -30 dB Attenuation (Typical) at 1 GHz
- 0.5 mm Thick UDFN Package with 0.40 mm Lead Pitch:
 - ♦ 8-Channel = 16-Lead UDFN
- Tiny UDFN Package Size:
 - 16-Lead: 3.30 mm x 1.35 mm
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD and Camera Data Lines in Mobile Handsets
- Wireless Handsets
- LCD and Camera Modules

ELECTRICAL SCHEMATIC



^{*}See Package/Pinout Diagrams for expanded pin information.



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UDFN16 DE SUFFIX CASE 517BE

MARKING DIAGRAM



P928 = CM1692-08DE M = Month Code ■ Pb-Free Package

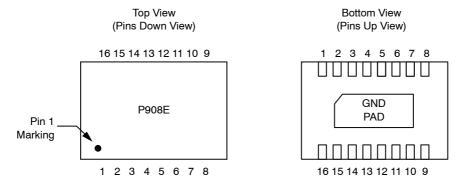
(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
CM1692-08DE	UDFN-16 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PACKAGE / PINOUT DIAGRAMS



CM1692-08DE 16-Lead UDFN Package

Table 1. PIN DESCRIPTIONS

Device Pin(s)	Name	Description	Device Pin(s)	Name	Description
1	FILTER1	Filter + ESD Channel 1	16	FILTER1	Filter + ESD Channel 1
2	FILTER2	Filter + ESD Channel 2	15	FILTER2	Filter + ESD Channel 2
3	FILTER3	Filter + ESD Channel 3	14	FILTER3	Filter + ESD Channel 3
4	FILTER4	Filter + ESD Channel 4	13	FILTER4	Filter + ESD Channel 4
5	FILTER5	Filter + ESD Channel 5	12	FILTER5	Filter + ESD Channel 5
6	FILTER6	Filter + ESD Channel 6	11	FILTER6	Filter + ESD Channel 6
7	FILTER7	Filter + ESD Channel 7	10	FILTER7	Filter + ESD Channel 7
8	FILTER8	Filter + ESD Channel 8	9	FILTER8	Filter + ESD Channel 8
GND PAD	GND	Device Ground			

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
Current per Inductor	30	mA
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
L	Channel Inductance			17		nH
C _{TOTAL}	Total Channel Capacitance	At 2.5 VDC Reverse Bias, 1 MHz, 30 mVAC	18.8	23.5	28.2	pF
С	Capacitance C1	At 2.5 VDC Reverse Bias, 1 MHz, 30 mVAC		11.8		pF
V _{DIODE}	Standoff Voltage	I _{DIODE} = 10 μA		6.0		V
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} = +3.3 V		0.1	1.0	μΑ
V_{SIG}	Signal Clamp Voltage (Note 3) Positive Clamp Negative Clamp	I _{LOAD} = 10 mA I _{LOAD} = -10 mA	5.6 -0.4	6.8 -0.8	9 –1.5	V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model (HBM), MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Notes 2 and 3)	±30 ±15			kV
R _{DYN}	Dynamic Resistance Positive Negative			2.3 0.9		Ω
f _C	Roll–off Frequency at –6 dB Attenuation Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω			400		MHz

T_A = 25°C unless otherwise specified.
 ESD applied to input and output pins with respect to GND, one at a time.
 Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin A1 then clamping voltage is measured at pin C1). Unused pins are left open.

PERFORMANCE INFORMATION

Typical Diode Capacitance vs. Input Voltage

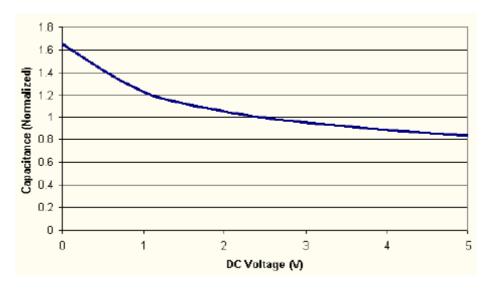


Figure 1. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5 VDC and 25°C)

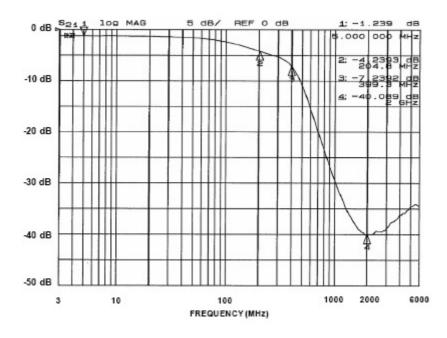
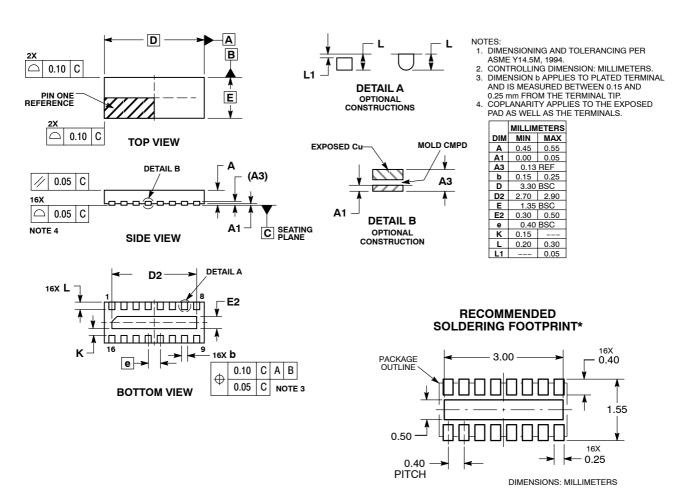


Figure 2. Typical Performance Curve

PACKAGE DIMENSIONS

UDFN16, 3.3x1.35, 0.4P CASE 517BE-01 ISSUE O



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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